

# SP6003 Synchronous Rectifier Driver

## DESCRIPTION

The fundamental of SP6003 synchronous rectifier (SR) driver IC is based on our U.S. patented methods that utilize the principle of "prediction" logic circuit. The IC deliberates previous cycle timing to control the SR in present cycle by "predictive" algorithm that makes adjustments to the turn-off time, in order to achieve maximum efficiency and avoid cross-conduction at the same time. It also maintains the MOSFET's body diode conduction at minimum level. The SP6003 is capable to adapt in almost all existing flyback converters with few adjustments considered necessary.

## FEATURES

- Offers efficiency improvement over Schottky Diode (depends on drive configuration of the SR).
- Drives all logic level Power MOSFET.
- Prediction gate timing control.
- Minimum MOSFET body diode conduction.
- Operating frequency up to 350 KHz.
- Synchronize to transformer secondary voltage waveform.

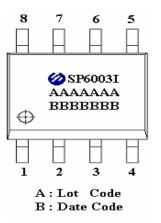
#### APPLICATIONS

- Servers & workstations
- Storage area network power supplies
- Telecommunication converters
- Embedded systems
- Industrial & commercial systems using high current processors

## PIN CONFIGURATION (SOP-8)

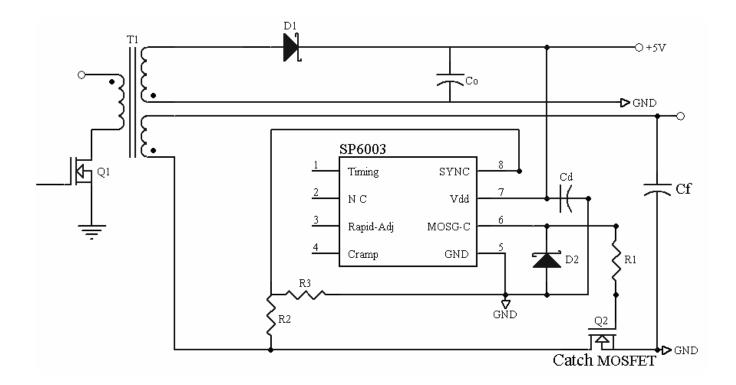


## PART MARKING





## TYPICAL APPLCATION CIRCUIT

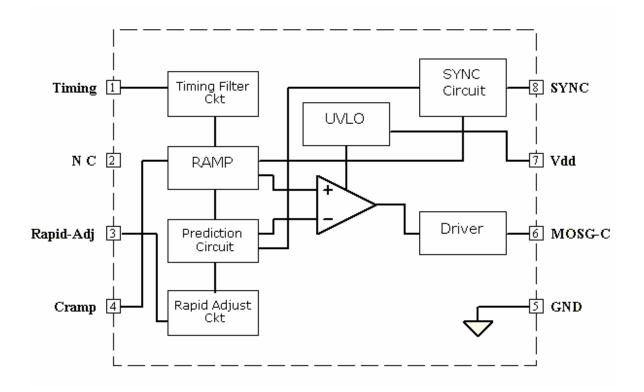


## **PIN DESCRIPTION**

Pin	Symbol	Description
1	Timing	Discontinuous current filter timing adjustment resistor connection.
2	NC	No connection.
3	Rapid-Adj	Capacitor connection to adjust fast pulse width reduction response.
4	Cramp	Ramp capacitor adjustment to extend MOSFET's gate timing.
5	GND	Ground connection.
6	MOSG-C	Catch MOSFET gate drive.
7	Vdd	DC supply voltage.
8	SYNC	Synchronized signal from transformer's output.



## **BLOCK DIAGRAM**



## **ORDERING INFORMATION**

Part Number	Package	Part Marking	
SP6003S8RG	SOP-8	SP6003I	
SP6003S8TG	SOP-8	SP6003I	

**※** SP6003S8RG : 7" Tape Reel ; Pb − Free

℁ SP6003S8TG : Tube ; Pb − Free

## ABSOULTE MAXIMUM RATINGS (TA=25°C, unless otherwise specified.)

The following ratings designate persistent limits beyond which damage to the device may occur.

Symbol	Parameter	Value	Unit
$V_{dd}$	DC Supply Voltage	7	V
SYNC	SYNC Voltage	7.5	V
I <sub>OUT</sub>	Peak Source Current (Pulsed)	1	A
	Peak Sink Current (Pulsed)	1.5	Α
P <sub>D</sub>	Power Dissipation @ $T_A=85^{\circ}C$ (*)	0.25	W
TJ	Operating Junction Temperature Range	-40 to 150	°C
T <sub>STG</sub>	Storage Temperature Range	-40 to 150	°C
T <sub>LEAD</sub>	Lead Soldering Temperature for 5 sec.	260	°C



## THERMAL RESISTANCE

Symbol	Parameter	Value	Unit
Rojc	Thermal Resistance Junction – Case (*)	45	°C/W

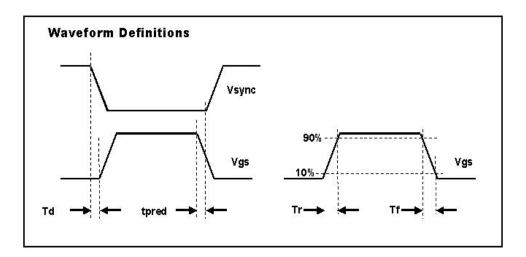
(\*) The power dissipation and thermal resistance are evaluated under copper board mounted with free air conditions.

## **ELECTRICAL CHARACTERISTICS**

(T<sub>A</sub>=25°C, V<sub>dd</sub>=5V, V<sub>SYNC</sub>=5V, Freq. =300 KHz, Duty Cycle=50%, unless otherwise specified.)

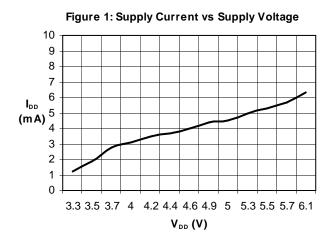
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
SUPPLY IN	PUT					
Idd	Supply current	No load	4	5.5	8	mA
Vonth	Vdd turn on threshold			5.0	7.0	V
Voffth	Vdd turn off threshold		3.8	4.1		V
SYNC REFI	ERENCE (SYNC)					
Vshth	SYNC high threshold		3.9	5.0		V
Vslth	SYNC low threshold			0.9	1.2	V
MOSFET G	ATE DRIVER (MOSG-C)					
Voh	Output high voltage	Io = -200 mA	4.8	4.9	5.0	V
Vol	Output low voltage	Io = 200 mA	0.0	0.1	0.2	V
Td	Propagation delay	No load	15	20	25	ns
Tr	Rise time	Load = 1nF(*)	24	28	36	ns
Tf	Fall time	Load = 1nF(*)	20	23	30	ns

(\*) Tr & Tf are measured among 10% and 90% of starting and final voltage.

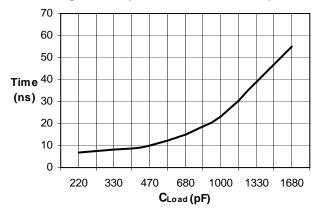


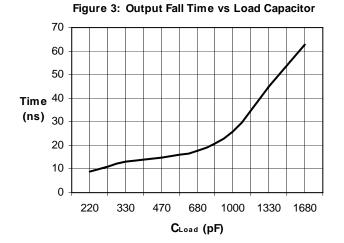


## **PERFORMANCE CHARACTERISTICS** (T<sub>A</sub>=25°C, unless otherwise specified.)









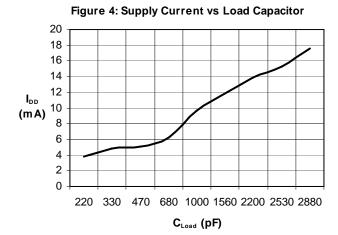
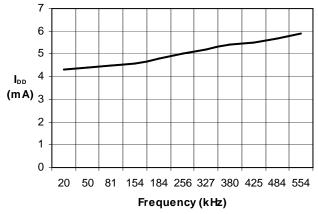
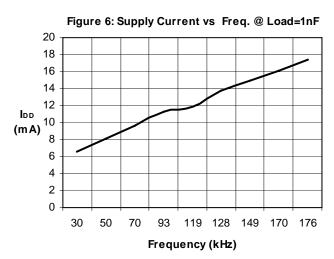


Figure 5: Supply Current vs Freq. @ No Load



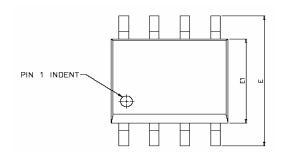


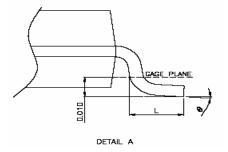
\*Fig. 2-4: Frequency = 85 kHz.

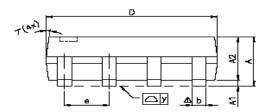
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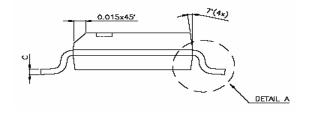


## **SOP- 8 PACKAGE OUTLINE**









0///00/0	DIMENSIONS IN MILLIMETERS		DIMENSIONS IN INCHES			
SYMBOLS	MIN	NOM	MAX	MIN	NOM	MAX
A	1.47	1.60	1.73	0.058	0.063	0.068
A1	0.10		0.25	0.004		0.010
A2		1.45			0.057	
b	0.33	0.41	0.51	0.013	0.016	0.020
С	0.19	0.20	0.25	0.0075	0.008	0.0098
D	4.80	4.85	4.95	0.189	0.191	0.195
Е	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
е	—	1.27	—		0.050	
L	0.38	0.71	1.27	0.015	0.028	0.050
∕∆ у			0.076			0.003
0	0.		8'	0.		8'



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